

**Review paper of Bandwidth Enhancement of Microstrip Antenna using
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Abstract: This paper represents the enhancement of bandwidth for microstrip antenna along with its structure. The survey includes the way to enhance bandwidth using special structure of patch instead rectangular patch. The antennas are very essential device for communication as it is used as a transmitter device and receiving device. For the microwave frequency communication the Microstrip patch antenna is the best choice. But it suffers from the problem of narrow bandwidth hence it necessary to overcome this disadvantage.

Keywords: Microstrip Patch Antenna, Bandwidth Improvement Of MSA, Structure Of MSA

I. INTRODUCTION:

Two most serious limitations of the microstrip antennas are its low gain and narrow bandwidth. The compact antenna configuration further deteriorates these two parameters. This is because of the fact that there is a fundamental relationship between the size, bandwidth and efficiency of an antenna. As antennas are made smaller, either the operating bandwidth or the antenna efficiency must decrease. The gain is also related to the size of the antenna, that is small antennas typically provide lower gain than larger antennas.

Therefore, the size reduction, together with gain and bandwidth enhancement is becoming a major design consideration for most practical applications of microstrip antennas for wireless communication. A number of techniques have been reported by the researchers to enhance the gain and bandwidth of microstrip antennas. Some of them used to enhance the gain are, loading of high permittivity dielectric superstrate [1], inclusion of an amplifier type active circuitry [2] and stacked configuration [3]. Use of superstrate loading technique helps in increasing the radiation efficiency. Amplifier circuits can also be integrated with the radiating patch to give rise to an active integrated antenna. In stacked configuration two patches, driven and parasitic, are used with desired feeding technique.

The narrow impedance bandwidth of the basic microstrip element is ultimately a consequence of its electrically thin ground-plane-backed dielectric substrate, which leads to a high Q resonance behavior. Bandwidth improves as the substrate thickness is increased, or the dielectric constant is reduced, but these trends are limited by an inductive impedance offset that increases with thickness. A logical approach, therefore, is to use a thick substrate or replacing the substrate by a porous thick foam [4] with some type of additional impedance matching to cancel this inductance. Thick substrate introduces surface wave excitation. Another method reported [5] for the bandwidth enhancement is by loading the suspended microstrip antenna with dielectric resonator.

The stacked patch arrangement [12] is very popular, with reported bandwidths ranging from 10% to 20%. Owing to the fact that the stacked configuration enhances both the gain and bandwidth, this particular choice is preferred in the present work.

II. FEEDING TECHNIQUES

Microstrip patch antennas can be fed by a variety of methods. These methods can be classified into two categories - contacting and non-contacting. In the contacting method, the RF power is fed directly to the radiating patch using a connecting element such as a microstripline. In the non-contacting scheme, electromagnetic field coupling is done to transfer power between the microstripline and the radiating patch. The four most popular feed techniques used are the microstripline, coaxial probe (both contacting schemes), aperture coupling and proximity coupling (both non-contacting schemes). The techniques are as follows.

- Microstripline feed
- Coaxial Feed
- Aperture Coupled Feed
- Proximity Coupled Feed
- Coplanar Waveguide Feed

BANDWIDTH OF MSA

The bandwidth of the patch is defined as the frequency range over which it is matched with that of the feed line within specified limits. In other words, the frequency range over which the antenna will perform satisfactorily. This means the channels have a larger usable frequency range and thus results in increased transmission. The bandwidth of an antenna is usually defined by the acceptable standing wave ratio (SWR) value over the concerned frequency range.

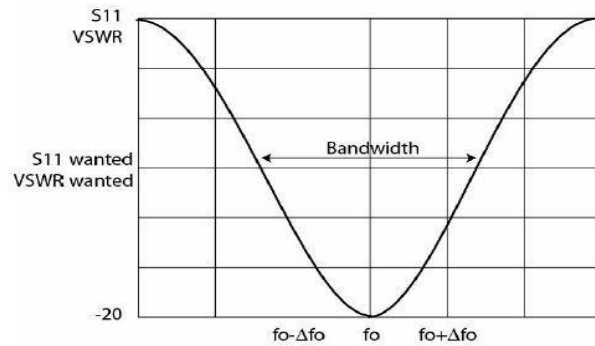


Figure: Bandwidth

HOW TO IMPROVE BANDWIDTH OF MSA

The demand for wireless communication is designing of proper wideband antenna. The microstrip is the best choice for wireless communication, but before using it in the field it is necessary to improve the bandwidth of it. There are lots of issues regarding the bandwidth enhancement of MSA. The possible ways to increase the bandwidth are as follows.

- 1 multilayer structure.
- 2 varying the patch size
- 3 stacked patches
- 4 parasitic patches.

The patch sizes are available such as U shape, E shape, L shape.

III. STACKED CONFIGURATION:

Stacked configurations are possible with aperture coupled feeding, proximity feeding and co-axial feeding. Probe-feeding technique is re-emerging in variety of antenna systems due to its robust nature. It provides good isolation between feed network and radiating elements and due to direct contact with the radiator reduces dielectric layer misalignment difficulties. It also yields good front-to-back ratio which is very important where multiple arrays are located back-to-back in close proximity. Therefore stacked configurations with probe-fed have been considered.

Considerable amount of literature is available which provides guidelines to design a probe-fed stacked patch. It has been reported that the combination of low dielectric constant and high dielectric constant can yield good impedance behavior. The broadest bandwidth can be achieved when the first-order mode on the lower patch is considerably greater in magnitude than corresponding mode on the top patch or in other words the top patch is loosely coupled. For this the substrate of lower patch should have higher dielectric constant than the upper substrate.

The thickness of each layer also plays an important role in achieving the overall bandwidth. The thicker the lower layer, the greater the bandwidth will be. It has been suggested that the lower patch should be designed such that it is strongly capacitive over the desired range of frequency instead of designing it for the minimum return loss. But the overall impedance will become inductive when parasitic patch is placed onto the configuration, if lower layer is too thick. Hence a trade-off must be made between the bandwidth and the impedance control.

The thickness of upper substrate (h_2) depends upon the thickness of lower substrate (h_1). The greater h_1 leaves less freedom for the h_2 . For lower return loss h_2 must be increased.

2.4 Design step for patch antenna

Specify: ϵ_r , f_r (in Hz), and h

For the designing purpose of patch antenna first the Resonant frequency (f_r), material of substrate, its dielectric constant (permittivity, ϵ_r) and its height (h) is decided.

Determine W , L and ϵ_{eff}

Various formulas for effective dielectric constant (ϵ_{eff}), length (L) and width (W) of the patch are as give below.

$W/h > 1$

$$\epsilon_{eff} = \frac{\epsilon_r + 1}{2} + \frac{\epsilon_r - 1}{2} \left[1 + 12 \frac{h}{W} \right]^{-1/2} \quad \dots (1)$$

$$\frac{\Delta L}{h} = \frac{(0.412) (\epsilon_{eff} + 0.3) \left(\frac{W}{h} + 0.264 \right)}{(\epsilon_{eff} - 0.258) \left(\frac{W}{h} + 0.8 \right)} \quad \dots (2)$$

$$L_{eff} = L + 2\Delta L \quad \dots (3)$$

$$W = \frac{1}{2f_r \sqrt{\mu_0 \epsilon_0}} (\sqrt{2} / \sqrt{(\epsilon_r + 1)})$$

$$= \frac{v_0}{2f_r} (\sqrt{2} / \sqrt{(\epsilon_r + 1)}) \quad \dots (4)$$

$$L = \frac{1}{2f_r \sqrt{\epsilon_{eff} \sqrt{(\epsilon_0 \mu_0)}}} - 2\Delta L \quad \dots (5)$$

$$f_r = \frac{1}{2L \sqrt{\epsilon_r \sqrt{(\epsilon_0 \mu_0)}}} = \frac{v_0}{2L \sqrt{\epsilon_r}} \quad \dots (6)$$

IV. CONCLUSION

The various aspects of microstrip antennas have been studied & presented in this paper. Such as structure of microstrip antenna its feeding techniques, designing step and different techniques. The main objective of this study is to make a special structure of patch to get better bandwidth than rectangular patch. The designing aspect related to software and fabrication processes are also presented in this paper.

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